



**T<sub>g</sub>(DSC) 175°C**  
**T<sub>d</sub>(TGA) 355°C**  
**CTI ≥ 600V**  
**(R-156AS\*, R-156YS)**

\*Thickness: 0.8mm or less

**Applications**  
**Automotive**  
 Automotive ECU, Automotive module, HEV/EV power control unit, DC/DC converter board, etc.



## Halogen-free

Laminate

**R-156AS R-156YS**

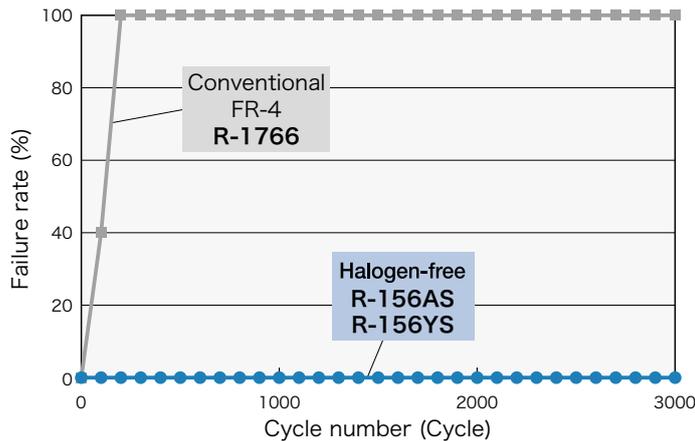
Prepreg

**R-155AS R-155YS**

Highly heat-resistant Halogen-free multi-layer circuit board materials

Added highly heat-resistant and tracking resistance to automotive quality R-1566 to improve the reliability of ECU boards used under severe conditions.

### Through-hole reliability

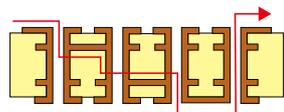


#### Condition

Cycle condition	-40°C (15min) ↔ 160°C (15min)
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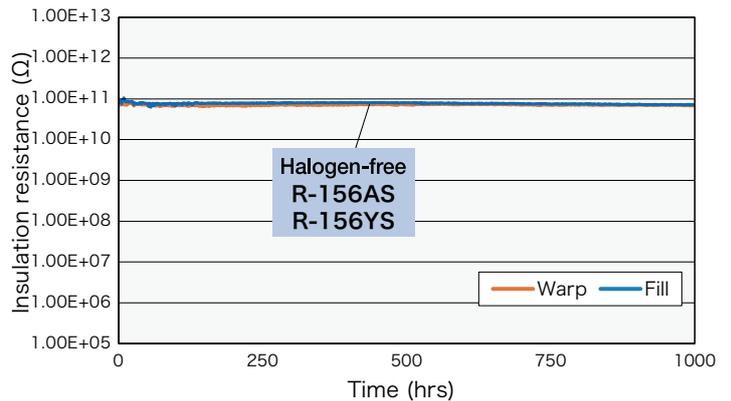
\* Failure is over 10% changes of resistance  
 \* 260°C Peak reflow x 3times as pretreatment

#### Construction



### Through-hole reliability

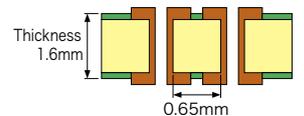
#### High voltage CAF evaluation



#### Condition

Pretreatment	260°C Peak reflow x 3times
Condition	85°C 85%RH DC 350V
Through-hole wall to wall distance	0.65mm

#### Construction



### General properties

Item	Test method	Condition	Unit	Halogen-free R-156AS	Halogen-free R-156YS	Conventional Halogen-free R-1566(W)	
Glass transition temp. (T <sub>g</sub> )	DSC	A	°C	175		148	
	TMA			170		145	
Thermal decomposition temp.(T <sub>d</sub> )	TGA	A	°C	355		350	
CTE z-axis	α1	IPC-TM-650 2.4.24	A	ppm/°C	40		40
					α2	180	
T288(with copper)	IPC-TM-650 2.4.24.1	A	min	10		3	
Peel strength	1oz(35μm)	IPC-TM-650 2.4.8	A	kN/m	1.6		1.8
Flammability	UL Method	C-48/23/50	—	94V-0*1	94V-1	94V-0	

The sample thickness is 0.8mm.

\*1 Thickness: 0.8mm maximum

Please see our website for Notes before you use.

industrial.panasonic.com/www/electronic-materials

Panasonic Industry R-156AS

Our Halogen-free materials are based on JPCA-ES-01-2003 standard and others.

The above data are typical values and not guaranteed values.